

SHINDENGEN

VX-2 Series Power MOSFET

N-Channel Enhancement type

2SK2198
(F30Z50VX2)

500V 30A

FEATURES

- Input capacitance (Ciss) is small.
Especially, input capacitance at 0 bias is small.
- The static Rds(on) is small.
- The switching time is fast.

APPLICATION

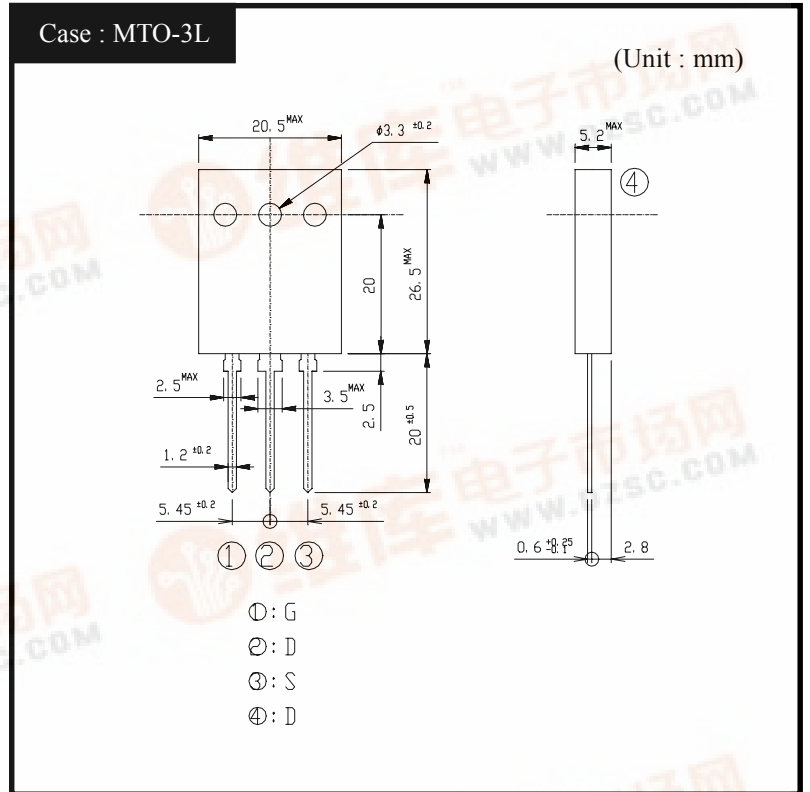
- Switching power supply of AC 100V input
- High voltage power supply
- Inverter

RATINGS

- Absolute Maximum Ratings (Tc = 25°C)

| Item | Symbol | Conditions | Ratings | Unit |
|---------------------------------|------------------|---------------------------------|---------|------|
| Storage Temperature | T _{stg} | | -55~150 | °C |
| Channel Temperature | T _{ch} | | 150 | |
| Drain-Source Voltage | V _{DSS} | | 500 | V |
| Gate-Source Voltage | V _{GSS} | | ±30 | |
| Continuous Drain Current (DC) | I _D | | 30 | A |
| Continuous Drain Current (Peak) | I _{DP} | | 90 | |
| Continuous Source Current (DC) | I _S | | 30 | |
| Total Power Dissipation | P _T | | 220 | W |
| Single Pulse Avalanche Current | I _{AS} | T _{ch} = 25°C | 30 | A |
| Mounting Torque | TOR | (Recommended torque : 0.5N·m) | 0.8 | N·m |

OUTLINE DIMENSIONS



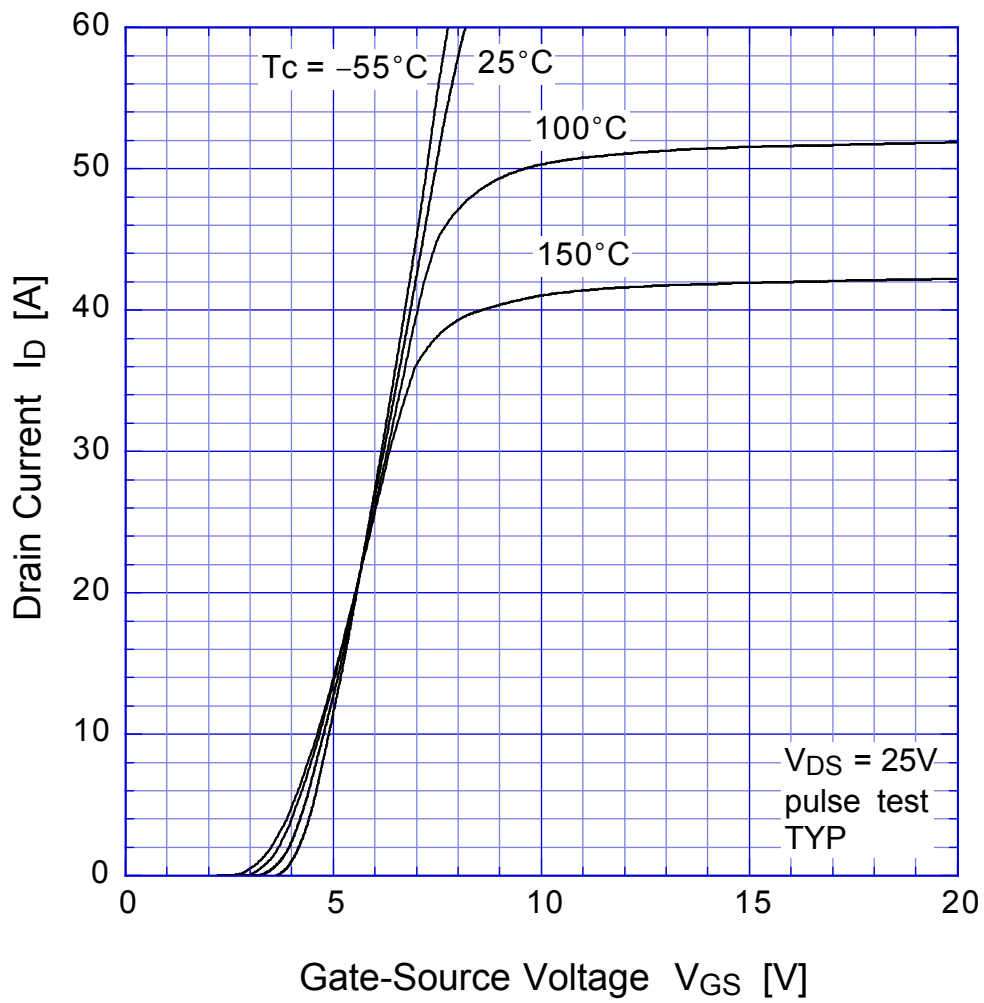
VX-2 Series Power MOSFET

2SK2198 (F30Z50VX2)

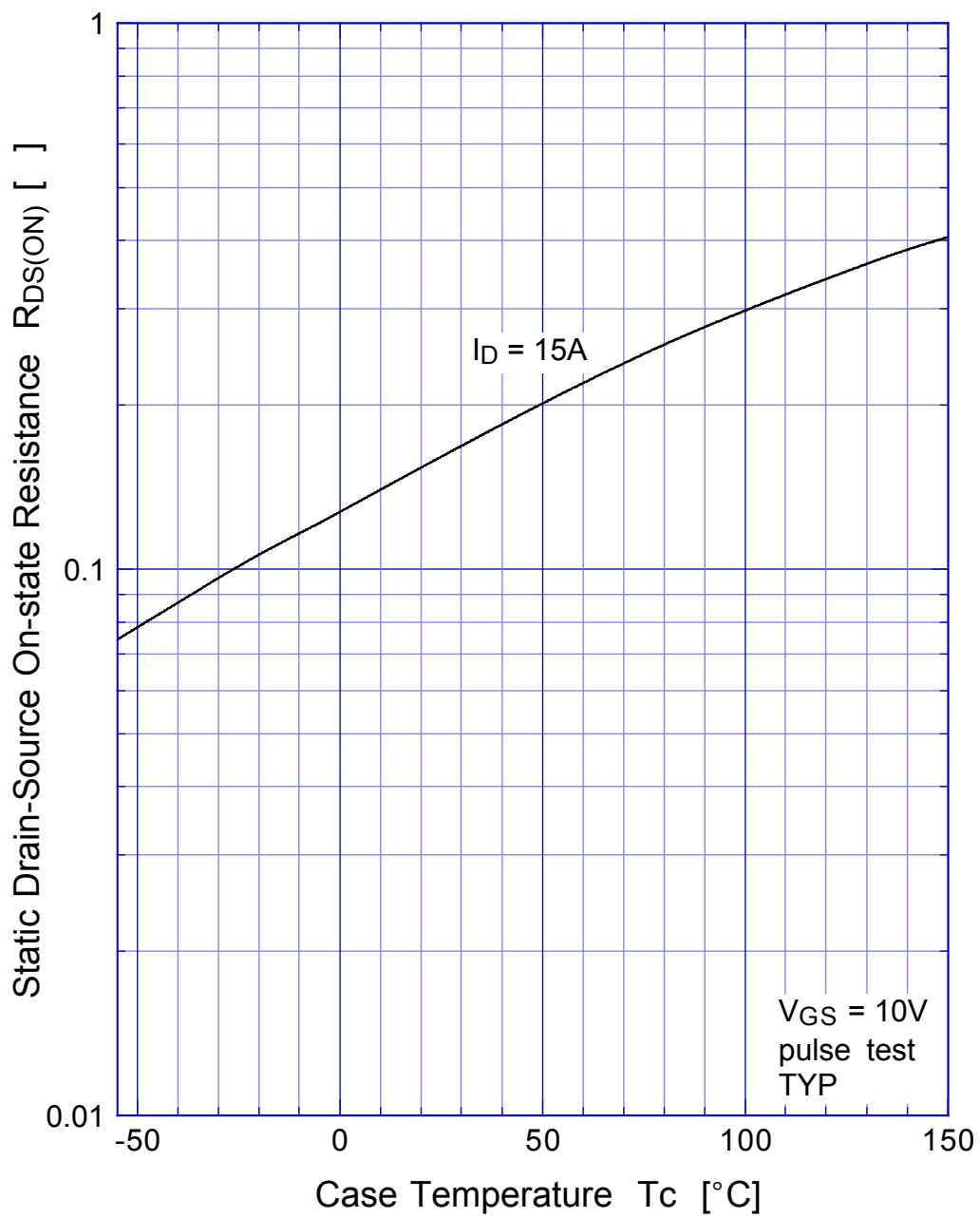
●Electrical Characteristics $T_c = 25^\circ\text{C}$

| Item | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|---|---------------|---|------|------|-----------|---------------------------|
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $I_D = 1\text{mA}, V_{GS} = 0\text{V}$ | 500 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 500\text{V}, V_{GS} = 0\text{V}$ | | | 250 | μA |
| Gate-Source Leakage Current | I_{GSS} | $V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$ | | | ± 0.1 | |
| Forward Transconductance | g_{fs} | $I_D = 15\text{A}, V_{DS} = 10\text{V}$ | 9 | 20 | | S |
| Static Drain-Source On-state Resistance | $R_{DS(ON)}$ | $I_D = 15\text{A}, V_{GS} = 10\text{V}$ | | 0.16 | 0.23 | Ω |
| Gate Threshold Voltage | V_{TH} | $I_D = 3\text{mA}, V_{DS} = 10\text{V}$ | 2.5 | 3.0 | 3.5 | V |
| Source-Drain Diode Forward Voltage | V_{SD} | $I_S = 15\text{A}, V_{GS} = 0\text{V}$ | | | 1.5 | |
| Thermal Resistance | θ_{jc} | junction to case | | | 0.568 | $^\circ\text{C}/\text{W}$ |
| Total Gate Charge | Q_g | $V_{DD} = 400\text{V}, V_{GS} = 10\text{V}, I_D = 30\text{A}$ | | 125 | | nC |
| Input Capacitance | C_{iss} | $V_{DS} = 10\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$ | | 3700 | | pF |
| Reverse Transfer Capacitance | C_{rss} | | | 230 | | |
| Output Capacitance | C_{oss} | | | 770 | | |
| Turn-On Time | t_{on} | $I_D = 15\text{A}, V_{GS} = 10\text{V}, R_L = 10\Omega$ | | 200 | 375 | ns |
| Turn-Off Time | t_{off} | | | 500 | 900 | |

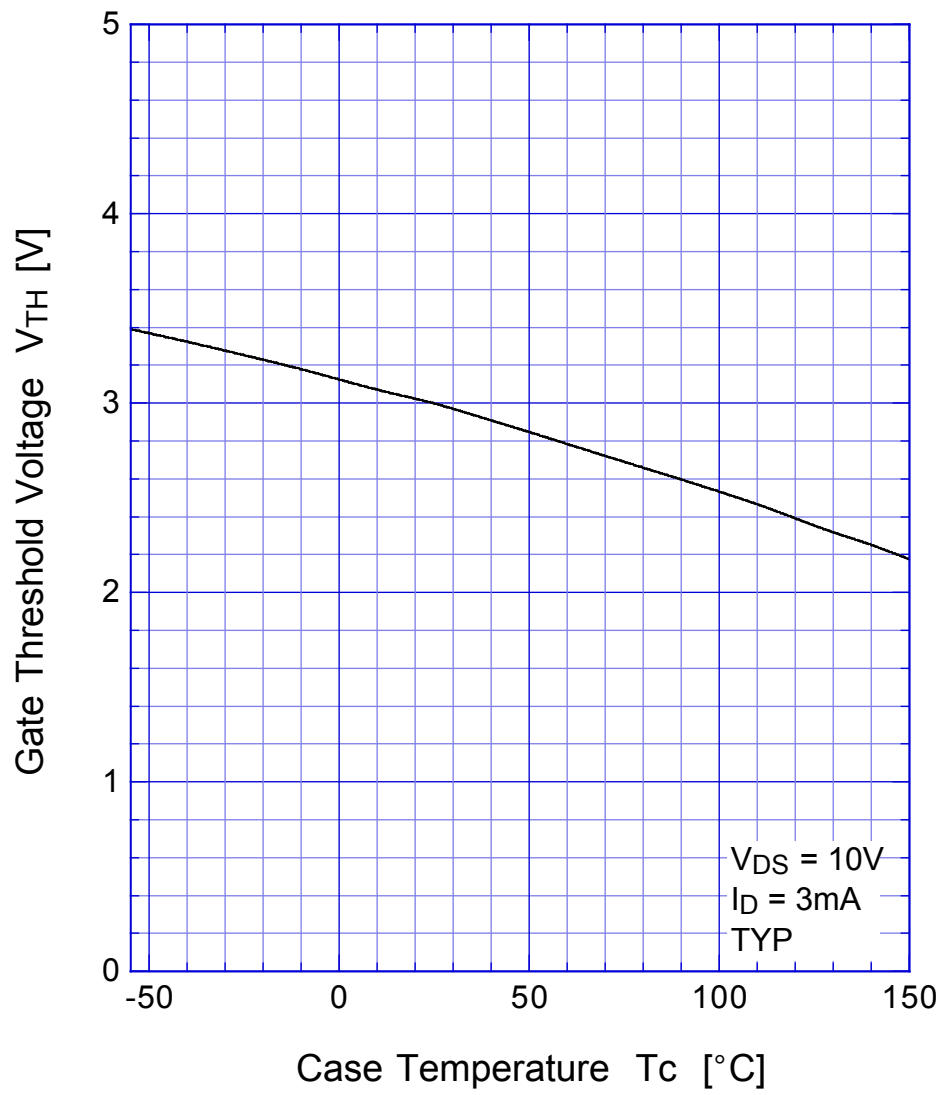
2SK2198 Transfer Characteristics



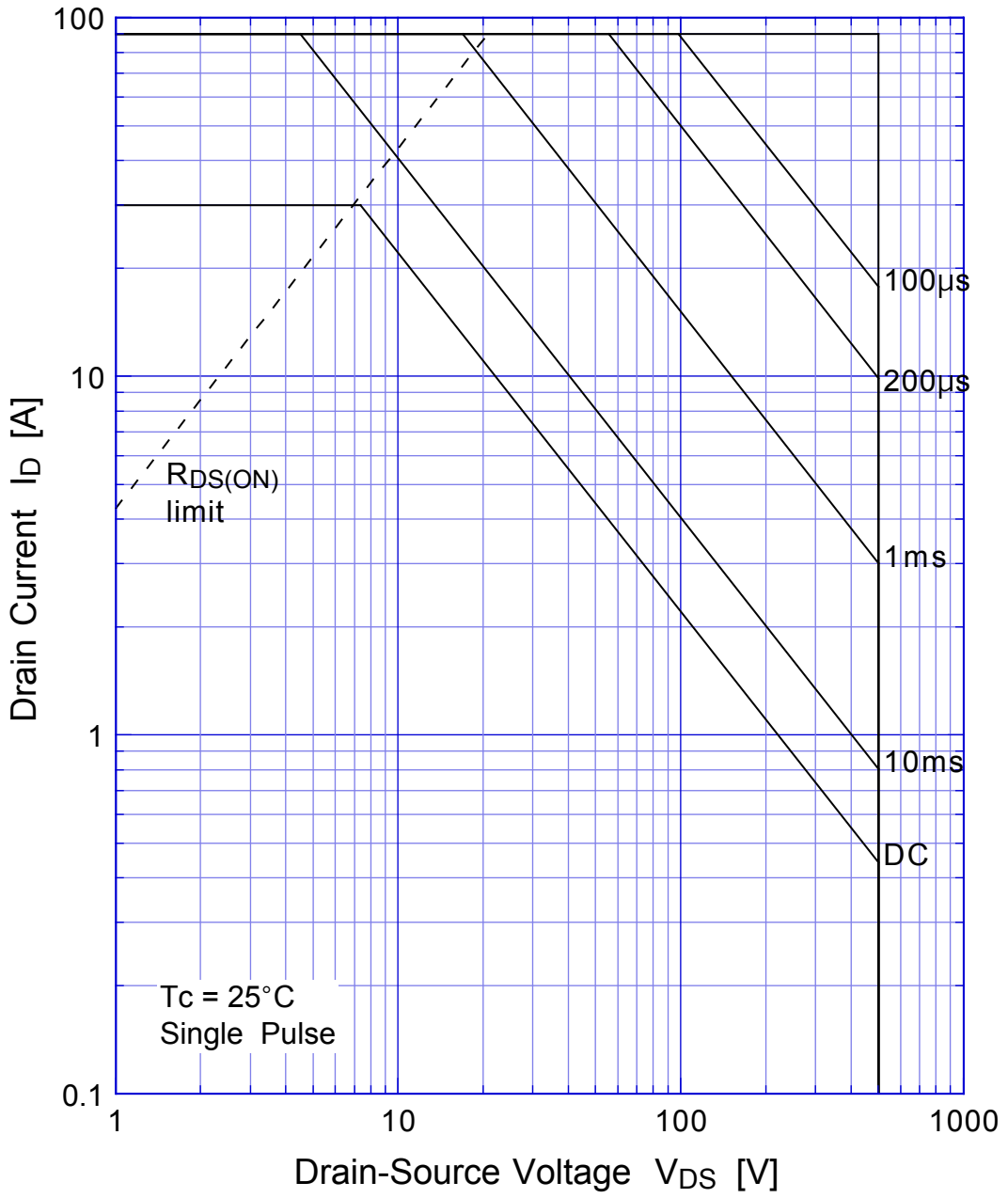
2SK2198 Static Drain-Source On-state Resistance



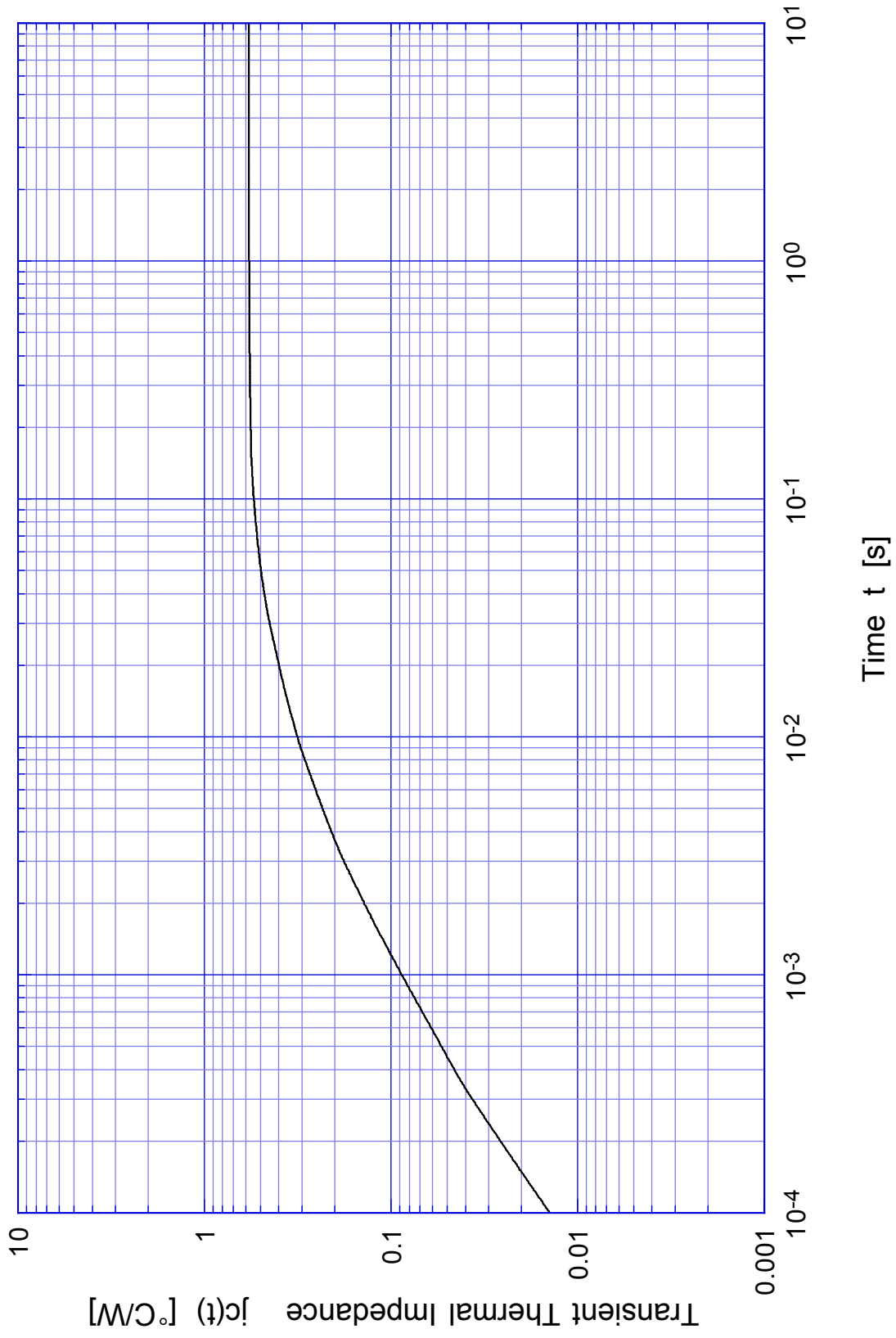
2SK2198 Gate Threshold Voltage



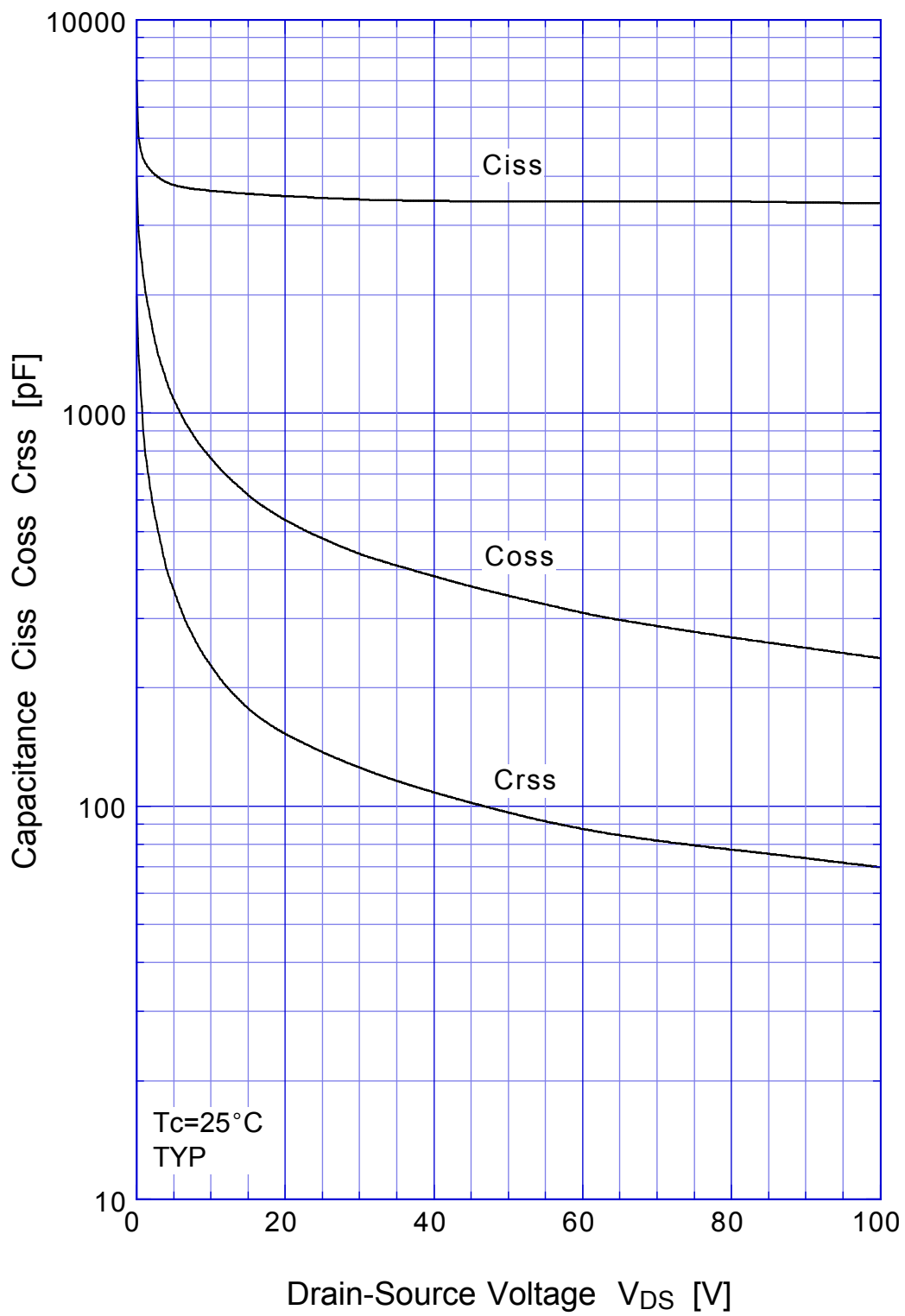
2SK2198 Safe Operating Area



2SK2198 Transient Thermal Impedance

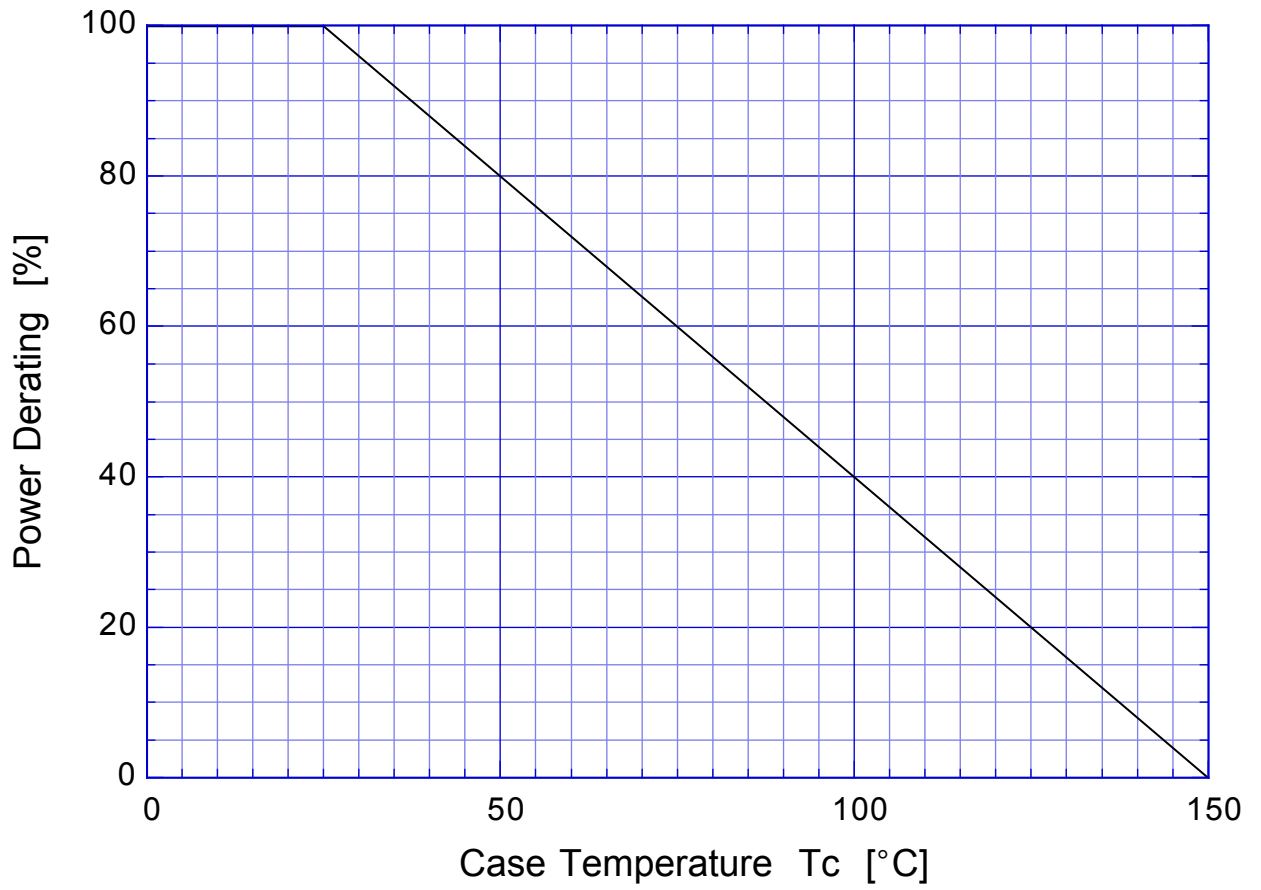


2SK2198 Capacitance



2SK2198

Power Derating



2SK2198 Gate Charge Characteristics

